# BLC8G27LS-240AV

# **Power LDMOS transistor**

**AMPLEON** 

Rev. 4 — 1 September 2015

Product data sheet

### 1. Product profile

#### 1.1 General description

240 W LDMOS packaged asymmetric Doherty power transistor for base station applications at frequencies from 2500 MHz to 2700 MHz.

#### Table 1. Typical performance

Typical RF performance at  $T_{\rm case}$  = 25 °C in an asymmetrical Doherty demo board.  $V_{\rm DS}$  = 28 V;  $I_{\rm Dq}$  = 500 mA (main);  $V_{\rm GS(amp)peak}$  = 0.5 V, unless otherwise specified.

Test signal	f	V <sub>DS</sub>	P <sub>L(AV)</sub>	G <sub>p</sub>	$\eta_D$	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
1-carrier W-CDMA	2500 to 2690	28	56	14.5	43	-35 <u>[1]</u>

<sup>[1]</sup> Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01% probability on CCDF per carrier.

#### 1.2 Features and benefits

- Excellent ruggedness
- High-efficiency
- Low thermal resistance providing excellent thermal stability
- Designed for broadband operation (2500 MHz to 2700 MHz)
- Asymmetric design to achieve optimum efficiency across the band
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent digital pre-distortion capability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

#### 1.3 Applications

 RF power amplifiers for base stations and multi carrier applications in the 2500 MHz to 2700 MHz frequency range

# 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	drain2 (peak)		
2	drain1 (main)	6 9 [[. 2 [ 1]]	2 ← 6
3	gate1 (main)		7
4	gate2 (peak)		3—
5	source [1]	7 8	4—1.—5
6	video decoupling (main)		8 <b>←</b>   <del>   </del>
7	n.c.		9
8	n.c.		1
9	video decoupling (peak)		aaa-009150

<sup>[1]</sup> Connected to flange.

## 3. Ordering information

Table 3. Ordering information

Type number	Package	Package				
	Name	Description	Version			
BLC8G27LS-240AV	-	plastic earless flanged cavity package; 8 leads	SOT1252-1			

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage		-	65	V
V <sub>GS(amp)main</sub>	main amplifier gate-source voltage		-0.5	+13	V
V <sub>GS(amp)peak</sub>	peak amplifier gate-source voltage		-0.5	+13	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C

Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-c)</sub>		$V_{DS} = 28 \text{ V}; I_{Dq} = 500 \text{ mA (main)};$	0.3	K/W
	to case	$V_{GS(amp)peak} = 0.5 \text{ V}; T_{case} = 80 ^{\circ}\text{C};$ $P_L = 56 \text{ W}$		

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### 6. Characteristics

Table 6. DC characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Main dev	rice					-
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 1.8 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 180 mA	1.5	1.9	2.3	V
$V_{GSq}$	gate-source quiescent voltage	$V_{DS}$ = 28 V; $I_{D}$ = 540 mA	1.6	2.1	2.4	V
I <sub>DSS</sub>	drain leakage current	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 28 V	-	-	2.8	μΑ
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	30	-	A
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V	-	-	280	nA
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 180 mA	-	1.63	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 6.3 \text{ A}$	-	83	135	mΩ
Peak dev	rice		·			-
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 2.2 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 220 mA	1.5	1.9	2.3	V
$V_{GSq}$	gate-source quiescent voltage	V <sub>DS</sub> = 28 V; I <sub>D</sub> = 660 mA	1.6	2.1	2.4	V
I <sub>DSS</sub>	drain leakage current	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 28 V	-	-	2.8	μΑ
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	40	-	A
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V	-	-	28	nΑ
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 220 mA	-	1.94	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 7.7 \text{ A}$	-	68	112	mΩ

#### Table 7. RF characteristics

Test signal: 1-carrier W-CDMA; PAR = 7.2 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f_1$  = 2500 MHz;  $f_2$  = 2690 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 500 mA (main);  $V_{GS(amp)peak}$  = 0.5 V;  $T_{case}$  = 25 °C; unless otherwise specified; in an asymmetrical Doherty production test circuit in 2500 MHz to 2690 MHz.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	P <sub>L(AV)</sub> = 56 W	12.8	14	-	dB
RLin	input return loss	P <sub>L(AV)</sub> = 56 W	-	-10	<b>-6</b>	dB
$\eta_{D}$	drain efficiency	P <sub>L(AV)</sub> = 56 W	32	37	-	%
ACPR	adjacent channel power ratio	P <sub>L(AV)</sub> = 56 W	-	-25	-20	dBc

### 7. Test information

#### 7.1 Ruggedness in class-AB operation

The BLC8G27LS-240AV is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 500 mA (main);  $V_{GS(amp)peak}$  =  $V_{GS}$  - 1 V ( $V_{GS}$ :  $I_{Dq}$  at 750 mA);  $P_L$  = 200 W (CW); f = 2500 MHz.

### 7.2 Impedance information

Table 8. Typical impedance of main device

Measured load-pull data of main device;  $I_{Dq} = 1000$  mA;  $V_{DS} = 28$  V. Typical values unless otherwise specified.

f	Z <sub>S</sub> [1]	Z <sub>L</sub> [1]	P <sub>L</sub> [2]	η <sub>D</sub> [2]	G <sub>p</sub> [2]		
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)		
Maximum p	Maximum power load						
2500	2.7 – j4.1	1.0 - j4.5	197	53.5	13.1		
2600	2.7 – j5.2	1.0 – j4.5	196	53.5	14.1		
2700	2.9 – j4.3	1.0 – j4.5	186	54.3	15.7		
Maximum o	drain efficiency lo	ad		,			
2500	2.7 – j4.1	1.7 – j3.9	159	62.6	15.2		
2600	2.7 – j5.2	1.5 – j3.7	144	61.2	16.5		
2700	2.9 - j4.3	1.4 – j4.1	149	58.5	17.2		

<sup>[1]</sup>  $Z_S$  and  $Z_L$  defined in Figure 1.

Table 9. Typical impedance of peak device

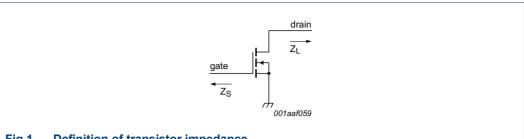
Measured load-pull data of peak device;  $I_{Dq} = 1230$  mA;  $V_{DS} = 28$  V. Typical values unless otherwise specified.

f	Z <sub>S</sub> [1]	Z <sub>L</sub> [1]	P <sub>L</sub> [2]	η <sub>D</sub> [2]	G <sub>p</sub> [2]
(MHz)	(Ω)	(Ω)	(W)	(%)	(dB)
Maximum po	wer load				
2500	2.5 – j5.6	2.1 – j4.9	256	53.3	13.7
2600	3.9 – j5.1	2.1 – j4.9	254	53.8	14.4
2700	3.4 – j4.2	2.6 – j5.1	240	53.3	15.9
Maximum dra	ain efficiency load				
2500	2.5 – j5.6	2.0 - j2.9	187	62.1	16.0
2600	3.9 – j5.1	1.8 – j3.1	177	60.4	16.9
2700	3.4 – j4.2	1.8 – j3.5	174	59.5	18.1

<sup>[1]</sup> Z<sub>S</sub> and Z<sub>L</sub> defined in Figure 1.

<sup>[2]</sup> at 3 dB gain compression.

<sup>[2]</sup> at 3 dB gain compression.



**Definition of transistor impedance** Fig 1.

### 7.3 VBW in Doherty operation

The BLC8G27LS-240AV shows 110 MHz (typical) video band-width in Doherty demo board in 2600 MHz at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 500 mA and  $V_{GS(amp)peak}$  = 0.5 V.

#### 7.4 Test circuit

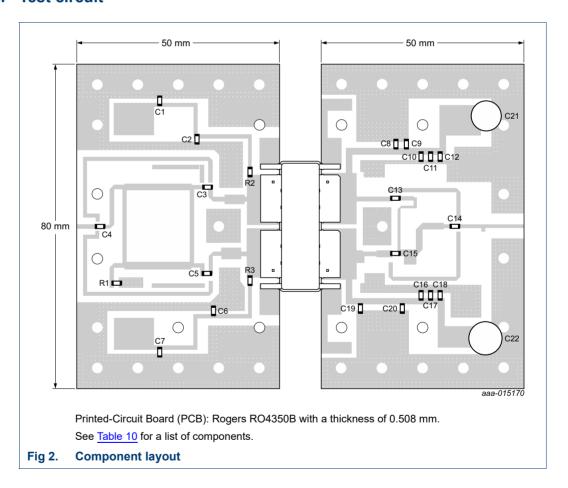


Table 10. List of components

For test circuit see Figure 2.

Component	Description	Value	Remarks
C1, C7	multilayer ceramic chip capacitor	0.1 μF, 50 V	Murata
C2, C3, C4, C5, C6, C8, C9, C13, C14, C15, C19, C20	multilayer ceramic chip capacitor	22 pF	ATC 600F
C10, C11, C12, C16, C17, C18	multilayer ceramic chip capacitor	4.7 μF, 50 V	Murata
C21, C22	electrolytic capacitor	2200 μF, 63 V	
R1	resistor	50 Ω	
R2, R3	chip resistor	9.1 Ω	SMD 0805

## 7.5 Graphical data

#### 7.5.1 CW

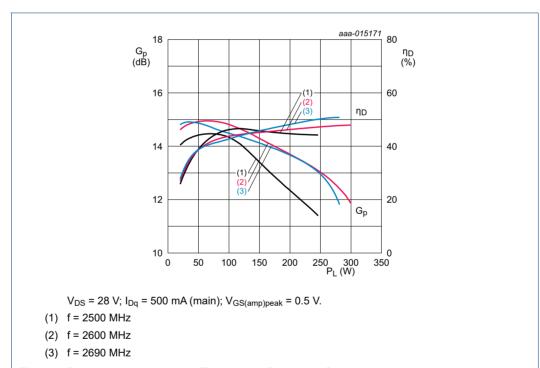
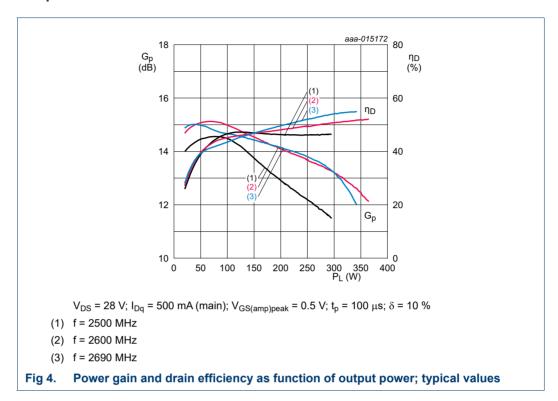
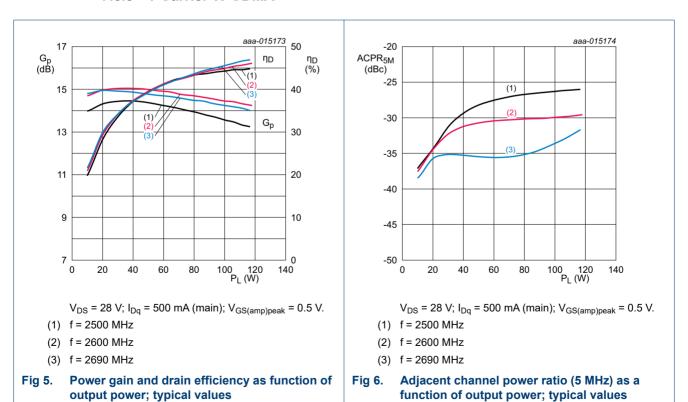


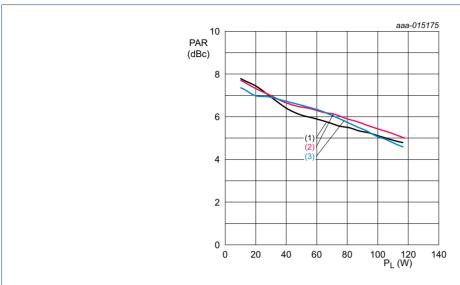
Fig 3. Power gain and drain efficiency as function of output power; typical values

#### 7.5.2 CW pulsed



#### 7.5.3 1-Carrier W-CDMA



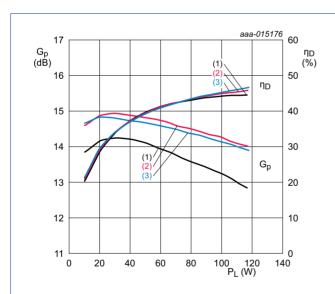


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 500 mA (main);  $V_{GS(amp)peak}$  = 0.5 V.

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2690 MHz

Fig 7. Peak-to-average ratio as a function of output power; typical values

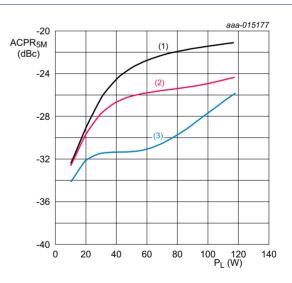
#### 7.5.4 2-Carrier W-CDMA



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 500 mA (main);  $V_{GS(amp)peak}$  = 0.5 V.

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2690 MHz

Fig 8. Power gain and drain efficiency as function of output power; typical values

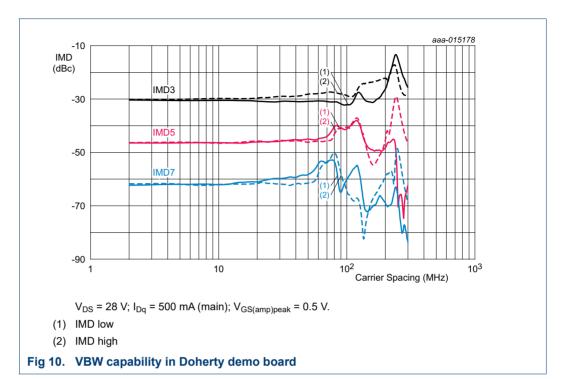


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 500 mA (main);  $V_{GS(amp)peak}$  = 0.5 V.

- (1) f = 2500 MHz
- (2) f = 2600 MHz
- (3) f = 2690 MHz

Fig 9. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

#### 7.5.5 2-Tone VBW



## 8. Package outline

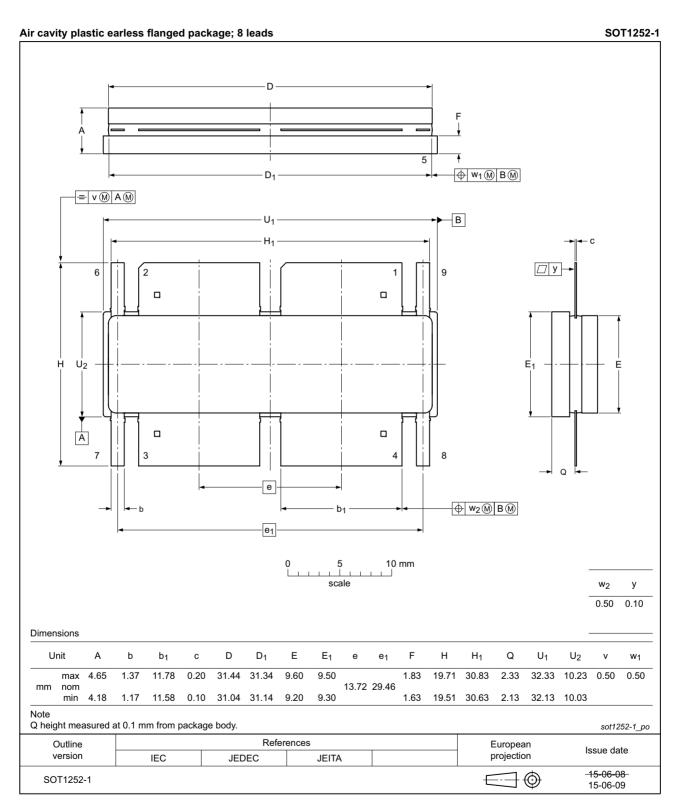


Fig 11. Package outline SOT1252-1

# 9. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

## 10. Abbreviations

Table 11. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
PAR	Peak-to-Average Ratio
SMD	Surface Mounted Device
VBW	Video Bandwidth
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

# 11. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BLC8G27LS-240AV#4	20150901	Product data sheet	-	BLC8G27LS-240AV v.3			
Modifications:	<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>						
BLC8G27LS-240AV v.3	20150728	Product data sheet	-	BLC8G27LS-240AV v.2			
BLC8G27LS-240AV v.2	20150603	Product data sheet	-	BLC8G27LS-240AV v.1			
BLC8G27LS-240AV v.1	20131104	Objective data sheet	-	-			

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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# **AMPLEON**

# BLC8G27LS-240AV

#### **Power LDMOS transistor**

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